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Details

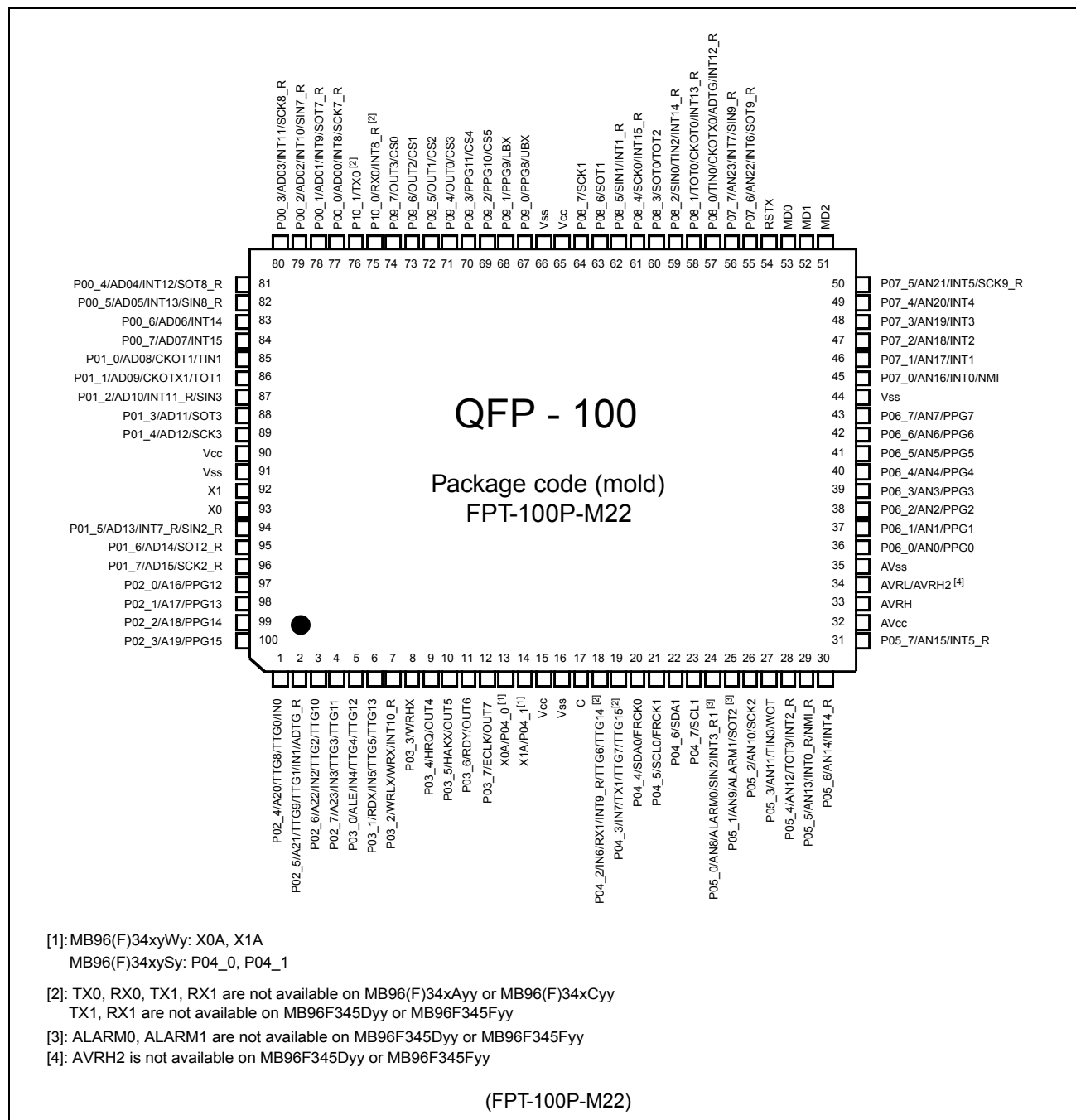
Product Status	Obsolete
Core Processor	F ² MC-16FX
Core Size	16-Bit
Speed	56MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, UART/USART
Peripherals	DMA, LVD, LVR, POR, PWM, WDT
Number of I/O	82
Program Memory Size	544KB (544K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	24K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 24x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-PQFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb96f348rsapqcr-gse2

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3. Pin Assignments

Figure 2. Pin assignment of MB96(F)34x (FPT-100P-M22)



[1]: MB96(F)34xyWy: X0A, X1A

MB96(F)34xySy: P04_0, P04_1

[2]: TX0, RX0, TX1, RX1 are not available on MB96(F)34xAyy or MB96(F)34xCyy
TX1, RX1 are not available on MB96F345Dyy or MB96F345Fyy

[3]: ALARM0, ALARM1 are not available on MB96F345Dyy or MB96F345Fyy

[4]: AVRH2 is not available on MB96F345Dyy or MB96F345Fyy

(FPT-100P-M22)

Remark:

MB96(F)34x products are pin-compatible to F²MC-16LX family MB90340 series.

8. User ROM Memory Map For Flash Devices

MB96F345D MB96F345F					
Alternative mode CPU address	Flash memory mode address	Flash size 160kByte +64KByte Data Flash			
FF:FFFF _H FF:0000 _H	3F:FFFF _H 3F:0000 _H	S39 - 64K	Flash A		
FE:FFFF _H FE:0000 _H	3E:FFFF _H 3E:0000 _H	S38 - 64K			
FD:FFFF _H FD:0000 _H	3D:FFFF _H 3D:0000 _H	External bus			
FC:FFFF _H FC:0000 _H	3C:FFFF _H 3C:0000 _H				
FB:FFFF _H FB:0000 _H	3B:FFFF _H 3B:0000 _H				
FA:FFFF _H FA:0000 _H	3A:FFFF _H 3A:0000 _H				
F9:FFFF _H F9:0000 _H	39:FFFF _H 39:0000 _H				
F8:FFFF _H F8:0000 _H	38:FFFF _H 38:0000 _H				
F7:FFFF _H F7:0000 _H	37:FFFF _H 37:0000 _H				
F6:FFFF _H F6:0000 _H	36:FFFF _H 36:0000 _H				
F5:FFFF _H F5:0000 _H	35:FFFF _H 35:0000 _H				
F4:FFFF _H F4:0000 _H	34:FFFF _H 34:0000 _H				
F3:FFFF _H F3:0000 _H	33:FFFF _H 33:0000 _H				
F2:FFFF _H F2:0000 _H	32:FFFF _H 32:0000 _H				
F1:FFFF _H F1:0000 _H	31:FFFF _H 31:0000 _H				
F0:FFFF _H F0:0000 _H	30:FFFF _H 30:0000 _H				
E0:FFFF _H E0:0000 _H					
DF:FFFF _H DF:8000 _H				Reserved	
DF:7FFF _H DF:6000 _H	1F:7FFF _H 1F:6000 _H			SA3 - 8K	Flash A
DF:5FFF _H DF:4000 _H	1F:5FFF _H 1F:4000 _H			SA2 - 8K	
DF:3FFF _H DF:2000 _H	1F:3FFF _H 1F:2000 _H			SA1 - 8K	
DF:1FFF _H DF:0000 _H	1F:1FFF _H 1F:0000 _H			SA0 - 8K ^[1]	
DE:FFFF _H DE:0000 _H				Reserved	
0E:FFFF _H 0E:FF00 _H	(0E:FFFF _H) (0E:FF00 _H)			SDA0-256 ^[2]	Data Flash A
0E:FEFF _H 0E:0000 _H				Reserved	
0D:FFFF _H 0D:C000 _H	(0F:FFFF _H) (0F:C000 _H)	SDA4-16K	Data Flash A		
0D:BFFF _H 0D:8000 _H	(0F:BFFF _H) (0F:8000 _H)	SDA3-16K			
0D:7FFF _H 0D:4000 _H	(0F:7FFF _H) (0F:4000 _H)	SDA2-16K			
0D:3FFF _H 0D:0000 _H	(0F:3FFF _H) (0F:0000 _H)	SDA1-16K			
0C:FFFF _H 0C:0000 _H		Reserved			

[1]: Sector SA0 contains the ROM Configuration Block RCBA at CPU address DF:0000_H - DF:007F_H

[2]: Sector SDA0 contains the ROM Configuration Block RCBA at CPU address DE:FF00_H - DE:FF2F_H

[1]: Sector SA0 contains the ROM Configuration Block RCBA at CPU address DF:0000_H - DF:007F_H

[2]: Sector SDA0 contains the ROM Configuration Block RCBDA at CPU address DE:FF00_H - DE:FF2F_H

Table 4: I/O map MB96(F)34x

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
0004B3 _H -0004BB _H	Reserved			-
0004BC _H	I/O Port P00 - External Pin State Register	EPSR00		R
0004BD _H	I/O Port P01 - External Pin State Register	EPSR01		R
0004BE _H	I/O Port P02 - External Pin State Register	EPSR02		R
0004BF _H	I/O Port P03 - External Pin State Register	EPSR03		R
0004C0 _H	I/O Port P04 - External Pin State Register	EPSR04		R
0004C1 _H	I/O Port P05 - External Pin State Register	EPSR05		R
0004C2 _H	I/O Port P06 - External Pin State Register	EPSR06		R
0004C3 _H	I/O Port P07 - External Pin State Register	EPSR07		R
0004C4 _H	I/O Port P08 - External Pin State Register	EPSR08		R
0004C5 _H	I/O Port P09 - External Pin State Register	EPSR09		R
0004C6 _H	I/O Port P10 - External Pin State Register	EPSR10		R
0004C7 _H -0004CF _H	Reserved			-
0004D0 _H	ADC analog input enable register 0	ADER0		R/W
0004D1 _H	ADC analog input enable register 1	ADER1		R/W
0004D2 _H	ADC analog input enable register 2	ADER2		R/W
0004D3 _H	ADC analog input enable register 3	ADER3		R/W
0004D4 _H	ADC analog input enable register 4	ADER4		R/W
0004D5 _H	Reserved			-
0004D6 _H	Peripheral Resource Relocation Register 0	PRRR0		R/W
0004D7 _H	Peripheral Resource Relocation Register 1	PRRR1		R/W
0004D8 _H	Peripheral Resource Relocation Register 2	PRRR2		R/W
0004D9 _H	Peripheral Resource Relocation Register 3	PRRR3		R/W
0004DA _H	Peripheral Resource Relocation Register 4	PRRR4		R/W
0004DB _H	Peripheral Resource Relocation Register 5	PRRR5		R/W
0004DC _H	Peripheral Resource Relocation Register 6	PRRR6		R/W
0004DD _H	Peripheral Resource Relocation Register 7	PRRR7		R/W
0004DE _H	Peripheral Resource Relocation Register 8	PRRR8		R/W
0004DF _H	Peripheral Resource Relocation Register 9	PRRR9		R/W
0004E0 _H	RTC - Sub Second Register L	WTBRL0	WTBR0	R/W
0004E1 _H	RTC - Sub Second Register M	WTBRH0		R/W
0004E2 _H	RTC - Sub-Second Register H	WTBR1		R/W

Table 4: I/O map MB96(F)34x

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
0006EB _H	External Bus - Area configuration register 5 High	EACH5		R/W
0006EC _H	External Bus - Area select register 2	EAS2		R/W
0006ED _H	External Bus - Area select register 3	EAS3		R/W
0006EE _H	External Bus - Area select register 4	EAS4		R/W
0006EF _H	External Bus - Area select register 5	EAS5		R/W
0006F0 _H	External Bus - Mode register	EBM		R/W
0006F1 _H	External Bus - Clock and Function register	EBCF		R/W
0006F2 _H	External Bus - Address output enable register 0	EBAE0		R/W
0006F3 _H	External Bus - Address output enable register 1	EBAE1		R/W
0006F4 _H	External Bus - Address output enable register 2	EBAE2		R/W
0006F5 _H	External Bus - Control signal register	EBCS		R/W
0006F6 _H -0006FF _H	Reserved			-
000700 _H	CAN0 - Control register Low	CTRLRL0	CTRLR0	R/W
000701 _H	CAN0 - Control register High (reserved)	CTRLRH0		R
000702 _H	CAN0 - Status register Low	STATRL0	STATR0	R/W
000703 _H	CAN0 - Status register High (reserved)	STATRH0		R
000704 _H	CAN0 - Error Counter Low (Transmit)	ERRCNTL0	ERRCNT0	R
000705 _H	CAN0 - Error Counter High (Receive)	ERRCNTH0		R
000706 _H	CAN0 - Bit Timing Register Low	BTRL0	BTR0	R/W
000707 _H	CAN0 - Bit Timing Register High	BTRH0		R/W
000708 _H	CAN0 - Interrupt Register Low	INTRL0	INTR0	R
000709 _H	CAN0 - Interrupt Register High	INTRH0		R
00070A _H	CAN0 - Test Register Low	TESTRL0	TESTR0	R/W
00070B _H	CAN0 - Test Register High (reserved)	TESTRH0		R
00070C _H	CAN0 - BRP Extension register Low	BRPERL0	BRPER0	R/W
00070D _H	CAN0 - BRP Extension register High (reserved)	BRPERH0		R
00070E _H -00070F _H	Reserved			-
000710 _H	CAN0 - IF1 Command request register Low	IF1CREQL0	IF1CREQ0	R/W
000711 _H	CAN0 - IF1 Command request register High	IF1CREQH0		R/W
000712 _H	CAN0 - IF1 Command Mask register Low	IF1CMSKL0	IF1CMSK0	R/W
000713 _H	CAN0 - IF1 Command Mask register High (reserved)	IF1CMSKH0		R
000714 _H	CAN0 - IF1 Mask 1 Register Low	IF1MSK1L0	IF1MSK10	R/W

Table 4: I/O map MB96(F)34x

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
000715 _H	CAN0 - IF1 Mask 1 Register High	IF1MSK1H0		R/W
000716 _H	CAN0 - IF1 Mask 2 Register Low	IF1MSK2L0	IF1MSK20	R/W
000717 _H	CAN0 - IF1 Mask 2 Register High	IF1MSK2H0		R/W
000718 _H	CAN0 - IF1 Arbitration 1 Register Low	IF1ARB1L0	IF1ARB10	R/W
000719 _H	CAN0 - IF1 Arbitration 1 Register High	IF1ARB1H0		R/W
00071A _H	CAN0 - IF1 Arbitration 2 Register Low	IF1ARB2L0	IF1ARB20	R/W
00071B _H	CAN0 - IF1 Arbitration 2 Register High	IF1ARB2H0		R/W
00071C _H	CAN0 - IF1 Message Control Register Low	IF1MCTRL0	IF1MCTR0	R/W
00071D _H	CAN0 - IF1 Message Control Register High	IF1MCTRH0		R/W
00071E _H	CAN0 - IF1 Data A1 Low	IF1DTA1L0	IF1DTA10	R/W
00071F _H	CAN0 - IF1 Data A1 High	IF1DTA1H0		R/W
000720 _H	CAN0 - IF1 Data A2 Low	IF1DTA2L0	IF1DTA20	R/W
000721 _H	CAN0 - IF1 Data A2 High	IF1DTA2H0		R/W
000722 _H	CAN0 - IF1 Data B1 Low	IF1DTB1L0	IF1DTB10	R/W
000723 _H	CAN0 - IF1 Data B1 High	IF1DTB1H0		R/W
000724 _H	CAN0 - IF1 Data B2 Low	IF1DTB2L0	IF1DTB20	R/W
000725 _H	CAN0 - IF1 Data B2 High	IF1DTB2H0		R/W
000726 _H -00073F _H	Reserved			-
000740 _H	CAN0 - IF2 Command request register Low	IF2CREQL0	IF2CREQ0	R/W
000741 _H	CAN0 - IF2 Command request register High	IF2CREQH0		R/W
000742 _H	CAN0 - IF2 Command Mask register Low	IF2CMSKL0	IF2CMSK0	R/W
000743 _H	CAN0 - IF2 Command Mask register High (reserved)	IF2CMSKH0		R
000744 _H	CAN0 - IF2 Mask 1 Register Low	IF2MSK1L0	IF2MSK10	R/W
000745 _H	CAN0 - IF2 Mask 1 Register High	IF2MSK1H0		R/W
000746 _H	CAN0 - IF2 Mask 2 Register Low	IF2MSK2L0	IF2MSK20	R/W
000747 _H	CAN0 - IF2 Mask 2 Register High	IF2MSK2H0		R/W
000748 _H	CAN0 - IF2 Arbitration 1 Register Low	IF2ARB1L0	IF2ARB10	R/W
000749 _H	CAN0 - IF2 Arbitration 1 Register High	IF2ARB1H0		R/W
00074A _H	CAN0 - IF2 Arbitration 2 Register Low	IF2ARB2L0	IF2ARB20	R/W
00074B _H	CAN0 - IF2 Arbitration 2 Register High	IF2ARB2H0		R/W
00074C _H	CAN0 - IF2 Message Control Register Low	IF2MCTRL0	IF2MCTR0	R/W
00074D _H	CAN0 - IF2 Message Control Register High	IF2MCTRH0		R/W

Table 4: I/O map MB96(F)34x

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
00074E _H	CAN0 - IF2 Data A1 Low	IF2DTA1L0	IF2DTA10	R/W
00074F _H	CAN0 - IF2 Data A1 High	IF2DTA1H0		R/W
000750 _H	CAN0 - IF2 Data A2 Low	IF2DTA2L0	IF2DTA20	R/W
000751 _H	CAN0 - IF2 Data A2 High	IF2DTA2H0		R/W
000752 _H	CAN0 - IF2 Data B1 Low	IF2DTB1L0	IF2DTB10	R/W
000753 _H	CAN0 - IF2 Data B1 High	IF2DTB1H0		R/W
000754 _H	CAN0 - IF2 Data B2 Low	IF2DTB2L0	IF2DTB20	R/W
000755 _H	CAN0 - IF2 Data B2 High	IF2DTB2H0		R/W
000756 _H -00077F _H	Reserved			-
000780 _H	CAN0 - Transmission Request 1 Register Low	TREQR1L0	TREQR10	R
000781 _H	CAN0 - Transmission Request 1 Register High	TREQR1H0		R
000782 _H	CAN0 - Transmission Request 2 Register Low	TREQR2L0	TREQR20	R
000783 _H	CAN0 - Transmission Request 2 Register High	TREQR2H0		R
000784 _H -00078F _H	Reserved			-
000790 _H	CAN0 - New Data 1 Register Low	NEWDT1L0	NEWDT10	R
000791 _H	CAN0 - New Data 1 Register High	NEWDT1H0		R
000792 _H	CAN0 - New Data 2 Register Low	NEWDT2L0	NEWDT20	R
000793 _H	CAN0 - New Data 2 Register High	NEWDT2H0		R
000794 _H -00079F _H	Reserved			-
0007A0 _H	CAN0 - Interrupt Pending 1 Register Low	INTPND1L0	INTPND10	R
0007A1 _H	CAN0 - Interrupt Pending 1 Register High	INTPND1H0		R
0007A2 _H	CAN0 - Interrupt Pending 2 Register Low	INTPND2L0	INTPND20	R
0007A3 _H	CAN0 - Interrupt Pending 2 Register High	INTPND2H0		R
0007A4 _H -0007AF _H	Reserved			-
0007B0 _H	CAN0 - Message Valid 1 Register Low	MSGVAL1L0	MSGVAL10	R
0007B1 _H	CAN0 - Message Valid 1 Register High	MSGVAL1H0		R
0007B2 _H	CAN0 - Message Valid 2 Register Low	MSGVAL2L0	MSGVAL20	R
0007B3 _H	CAN0 - Message Valid 2 Register High	MSGVAL2H0		R
0007B4 _H -0007CD _H	Reserved			-
0007CE _H	CAN0 - Output enable register	COER0		R/W
0007CF _H -0007FF _H	Reserved			-
000800 _H	CAN1 - Control register Low	CTRLRL1	CTRLRL1	R/W

12. Interrupt Vector Table

Table 5: Interrupt vector table MB96(F)34x

Vector number	Offset in vector table	Vector name	Cleared by DMA	Index in ICR to program	Description
0	3FC _H	CALLV0	No	-	
1	3F8 _H	CALLV1	No	-	
2	3F4 _H	CALLV2	No	-	
3	3F0 _H	CALLV3	No	-	
4	3EC _H	CALLV4	No	-	
5	3E8 _H	CALLV5	No	-	
6	3E4 _H	CALLV6	No	-	
7	3E0 _H	CALLV7	No	-	
8	3DC _H	RESET	No	-	
9	3D8 _H	INT9	No	-	
10	3D4 _H	EXCEPTION	No	-	
11	3D0 _H	NMI	No	-	Non-Maskable Interrupt
12	3CC _H	DLY	No	12	Delayed Interrupt
13	3C8 _H	RC_TIMER	No	13	RC Timer
14	3C4 _H	MC_TIMER	No	14	Main Clock Timer
15	3C0 _H	SC_TIMER	No	15	Sub Clock Timer
16	3BC _H	RESERVED	No	16	Reserved
17	3B8 _H	EXTINT0	Yes	17	External Interrupt 0
18	3B4 _H	EXTINT1	Yes	18	External Interrupt 1
19	3B0 _H	EXTINT2	Yes	19	External Interrupt 2
20	3AC _H	EXTINT3	Yes	20	External Interrupt 3
21	3A8 _H	EXTINT4	Yes	21	External Interrupt 4
22	3A4 _H	EXTINT5	Yes	22	External Interrupt 5
23	3A0 _H	EXTINT6	Yes	23	External Interrupt 6
24	39C _H	EXTINT7	Yes	24	External Interrupt 7
25	398 _H	EXTINT8	Yes	25	External Interrupt 8
26	394 _H	EXTINT9	Yes	26	External Interrupt 9
27	390 _H	EXTINT10	Yes	27	External Interrupt 10
28	38C _H	EXTINT11	Yes	28	External Interrupt 11
29	388 _H	EXTINT12	Yes	29	External Interrupt 12

14. Electrical Characteristics

14.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage	V_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	
	AV_{CC}	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_{CC} = AV_{CC}$ [1]
AD Converter voltage references	AVRH, AVRL	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$AV_{CC} \geq AVRH$, $AV_{CC} \geq AVRL$, $AVRH > AVRL$, $AVRL \geq AV_{SS}$
Input voltage	V_I	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_I \leq V_{CC} + 0.3V$ [2]
Output voltage	V_O	$V_{SS} - 0.3$	$V_{SS} + 6.0$	V	$V_O \leq V_{CC} + 0.3V$ [2]
Maximum Clamp Current	I_{CLAMP}	-4.0	+4.0	mA	Applicable to general purpose I/O pins [3]
Total Maximum Clamp Current	$\Sigma I_{CLAMP} $	-	40	mA	Applicable to general purpose I/O pins [3]
"L" level maximum output current	I_{OL1}	-	15	mA	Normal outputs with driving strength set to 5mA
"L" level average output current	I_{OLAV1}	-	5	mA	Normal outputs with driving strength set to 5mA
"L" level maximum overall output current	ΣI_{OL1}	-	100	mA	Normal outputs
"L" level average overall output current	ΣI_{OLAV1}	-	50	mA	Normal outputs
"H" level maximum output current	I_{OH1}	-	-15	mA	Normal outputs with driving strength set to 5mA
"H" level average output current	I_{OHAV1}	-	-5	mA	Normal outputs with driving strength set to 5mA
"H" level maximum overall output current	ΣI_{OH1}	-	-100	mA	Normal outputs
"H" level average overall output current	ΣI_{OHAV1}	-	-50	mA	Normal outputs
Permitted Power dissipation (Flash devices in QFP package) [4]	P_D	-	430 ^[5]	mW	$T_A = 105^\circ C$
		-	750 ^[5]	mW	$T_A = 90^\circ C$
		-	540 ^[5]	mW	$T_A = 125^\circ C$, no Flash program/erase [6]
Permitted Power dissipation (MB96F346/F347/F348 in LQFP package) [4]	P_D	-	375 ^[5]	mW	$T_A = 105^\circ C$
		-	750 ^[5]	mW	$T_A = 85^\circ C$
		-	470 ^[5]	mW	$T_A = 125^\circ C$, no Flash program/erase [6]
		-	560 ^[5]	mW	$T_A = 120^\circ C$, no Flash program/erase [6]
Permitted Power dissipation (MB96F345 in LQFP package) [4]	P_D	-	335 ^[5]	mW	$T_A = 105^\circ C$
		-	670 ^[5]	mW	$T_A = 85^\circ C$
		-	840 ^[5]	mW	$T_A = 75^\circ C$
		-	420 ^[5]	mW	$T_A = 125^\circ C$, no Flash program/erase [6]
		-	590 ^[5]	mW	$T_A = 115^\circ C$, no Flash program/erase [6]

14.3 DC characteristics

($T_A = -40^{\circ}\text{C}$ to 125°C , $V_{CC} = AV_{CC} = 3.0\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

Parameter	Symbol	Pin	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input H voltage	V_{IH}	Port inputs Pnn_m	CMOS Hysteresis 0.8/0.2 input selected	$0.8 V_{CC}$	-	$V_{CC} + 0.3$	V	
			CMOS Hysteresis 0.7/0.3 input selected	$0.7 V_{CC}$	-	$V_{CC} + 0.3$	V	$V_{CC} \geq 4.5\text{V}$
			AUTOMOTIVE Hys- teresis input selected	$0.74 V_{CC}$	-	$V_{CC} + 0.3$	V	$V_{CC} < 4.5\text{V}$
			TTL input selected	2.0	-	$V_{CC} + 0.3$	V	
	V_{IHX0F}	X0	External clock in "Fast Clock Input mode"	$0.8 V_{CC}$	-	$V_{CC} + 0.3$	V	Not available in MB96F34xY/R/AxA
	V_{IHX0S}	X0,X1, X0A,X1A	External clock in "oscil- lation mode"	2.5	-	$V_{CC} + 0.3$	V	
	V_{IHR}	RSTX	-	$0.8 V_{CC}$	-	$V_{CC} + 0.3$	V	CMOS Hysteresis input
	V_{IHM}	MD2-MD0	-	$V_{CC} - 0.3$	-	$V_{CC} + 0.3$	V	
Input L voltage	V_{IL}	Port inputs Pnn_m	CMOS Hysteresis 0.8/0.2 input selected	$V_{SS} - 0.3$	-	$0.2 V_{CC}$	V	
			CMOS Hysteresis 0.7/0.3 input selected	$V_{SS} - 0.3$	-	$0.3 V_{CC}$	V	
			AUTOMOTIVE Hys- teresis input selected	$V_{SS} - 0.3$	-	$0.5 V_{CC}$	V	$V_{CC} \geq 4.5\text{V}$
			TTL input selected	$V_{SS} - 0.3$	-	0.8	V	$V_{CC} < 4.5\text{V}$
	V_{ILX0F}	X0	External clock in "Fast Clock Input mode"	$V_{SS} - 0.3$	-	$0.2 V_{CC}$	V	Not available in MB96F34xY/R/AxA
	V_{ILX0S}	X0,X1, X0A,X1A	External clock in "oscillation mode"	$V_{SS} - 0.3$	-	0.4	V	
	V_{ILR}	RSTX	-	$V_{SS} - 0.3$	-	$0.2 V_{CC}$	V	CMOS Hysteresis input
	V_{ILM}	MD2-MD0	-	$V_{SS} - 0.3$	-	$V_{SS} + 0.3$	V	
Output H voltage	V_{OH2}	Normal outputs	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ $I_{OH} = -2\text{mA}$	$V_{CC} - 0.5$	-	-	V	Driving strength set to 2mA
			$3.0\text{V} \leq V_{CC} < 4.5\text{V}$ $I_{OH} = -1.6\text{mA}$					
	V_{OH5}	Normal outputs	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ $I_{OH} = -5\text{mA}$	$V_{CC} - 0.5$	-	-	V	Driving strength set to 5mA
			$3.0\text{V} \leq V_{CC} < 4.5\text{V}$ $I_{OH} = -3\text{mA}$					
	V_{OH3}	3mA outputs	$4.5\text{V} \leq V_{CC} \leq 5.5\text{V}$ $I_{OH} = -3\text{mA}$	$V_{CC} - 0.5$	-	-	V	
			$3.0\text{V} \leq V_{CC} < 4.5\text{V}$ $I_{OH} = -2\text{mA}$					

($T_A = -40^{\circ}\text{C}$ to 125°C , $V_{CC} = AV_{CC} = 3.0\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

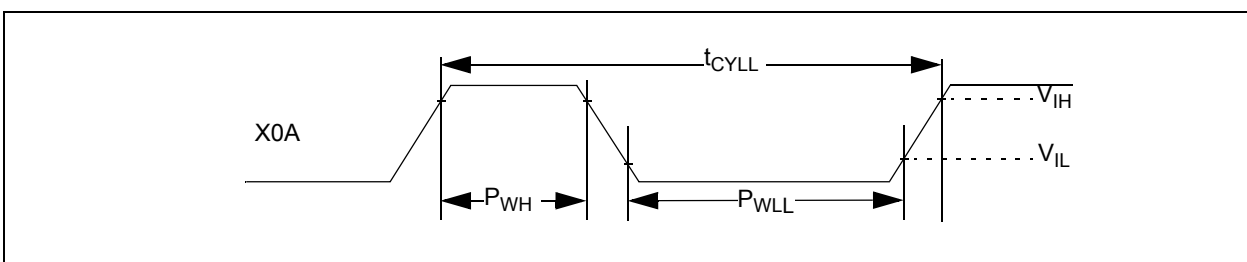
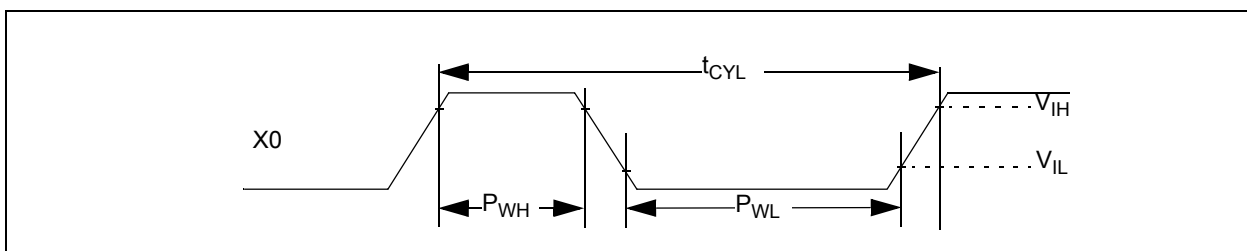
Parameter	Symbol	Condition (at T_A)		Value			Remarks
				Typ	Max	Unit	
Power supply current in Timer modes ^[1]	I_{CCTRCL}	RC Timer mode with CLKRC = 100kHz, SMCR:LPMSS = 0 (CLKMC, CLKPLL and CLKSC stopped. Voltage regulator in high power mode)	+25°C	0.3	0.45	mA	MB96F346/F347/F348
			+125°C	0.8	3.2		
			+25°C	0.08	0.15	mA	MB96F345
			+125°C	0.58	2.95		
			+25°C	0.3	0.45	mA	MB96345/346
			+125°C	0.8	2.2		
		RC Timer mode with CLKRC = 100kHz, SMCR:LPMSS = 1 (CLKMC, CLKPLL and CLKSC stopped. Voltage regulator in low power mode)	+25°C	0.05	0.1	mA	Flash devices
			+125°C	0.55	2.85		
			+25°C	0.05	0.1	mA	MB96345/346
			+125°C	0.55	1.85		
	I_{CCTSUB}	Sub Timer mode with CLKSC = 32kHz (CLKMC, CLKPLL and CLKRC stopped)	+25°C	0.03	0.1	mA	Flash devices
			+125°C	0.53	2.85		
			+25°C	0.03	0.1	mA	MB96345/346
			+125°C	0.53	1.85		
Power supply current in Stop Mode	I_{CCH}	VR CR:LPMB[2:0] = 110 _B (Core voltage at 1.8V)	+25°C	0.02	0.08	mA	Flash devices
			+125°C	0.52	2.8		
			+25°C	0.02	0.08	mA	MB96345/346
			+125°C	0.52	1.8		
		VR CR:LPMB[2:0] = 000 _B (Core voltage at 1.2V)	+25°C	0.015	0.06	mA	Flash devices
			+125°C	0.4	2.3		
			+25°C	0.015	0.06	mA	MB96345/346
			+125°C	0.4	1.4		
Power supply current for active Low Voltage detector	I_{CCLVD}	Low voltage detector enabled (RCR:LVDE = 1)	-	5	10	μA	MB96F345 Must be added to all current above
			+25°C	90	140	μA	Other devices Must be added to all current above
			+125°C	100	150		

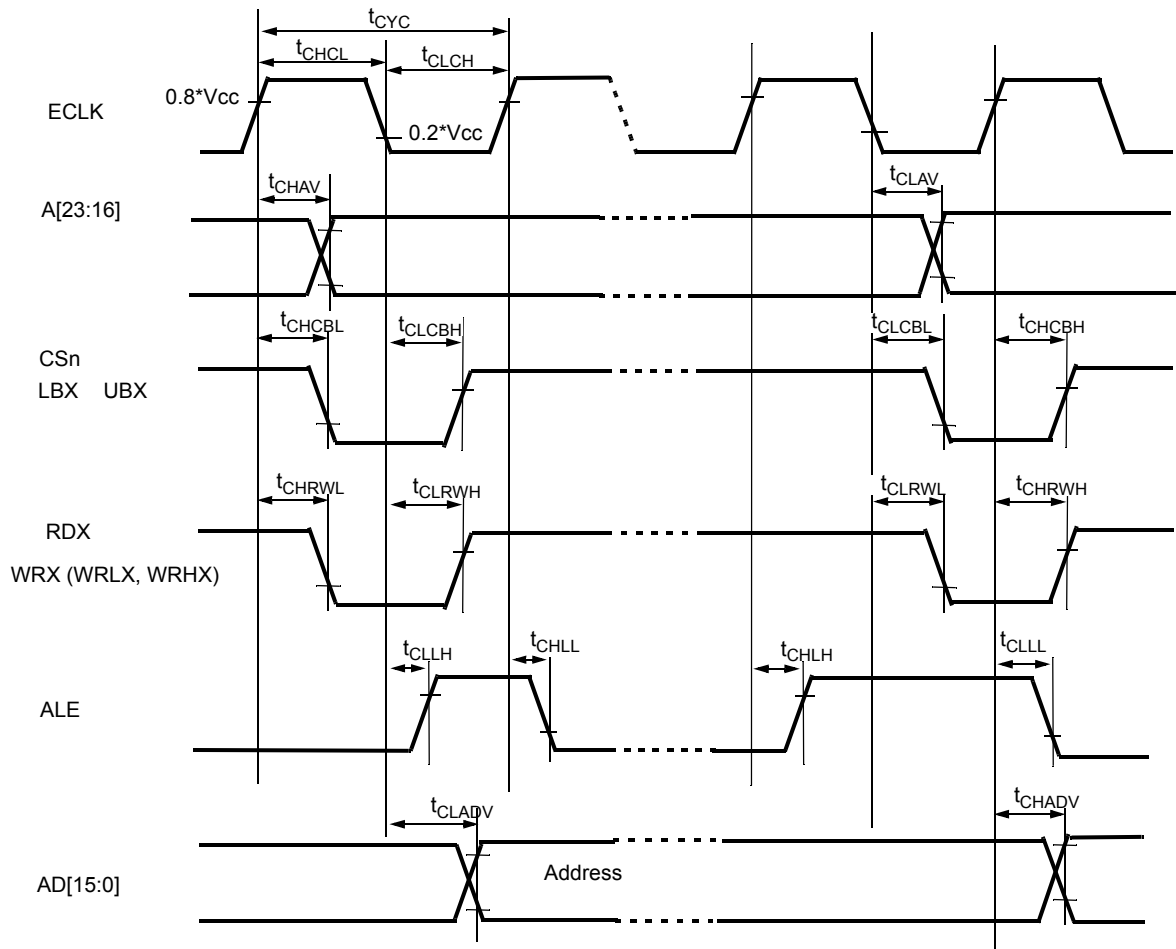
14.4 AC Characteristics

14.4.1 Source Clock timing

($T_A = -40^{\circ}\text{C}$ to 125°C , $V_{CC} = AV_{CC} = 3.0\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	f_C	X0, X1	3	-	16	MHz	When using a crystal oscillator, PLL off
			0	-	16	MHz	When using an opposite phase external clock, PLL off
			3.5	-	16	MHz	When using a crystal oscillator or opposite phase external clock, PLL on
Clock frequency	f_{FCI}	X0	0	-	56	MHz	When using a single phase external clock in "Fast Clock Input mode" (not available in MB96F34xY/R/AxA), PLL off
			3.5	-	56	MHz	When using a single phase external clock in "Fast Clock Input mode" (not available in MB96F34xY/R/AxA), PLL on
Clock frequency	f_{CL}	X0A, X1A	32	32.768	100	kHz	When using an oscillation circuit
			0	-	100	kHz	When using an opposite phase external clock
		X0A	0	-	50	kHz	When using a single phase external clock
Clock frequency	f_{CR}	-	50	100	200	kHz	When using slow frequency of RC oscillator
			1	2	4	MHz	When using fast frequency of RC oscillator
PLL Clock frequency	f_{CLKVCO}	-	64	-	200	MHz	Permitted VCO output frequency of PLL (CLKVCO)
PLL Phase Jitter	T_{PSKEW}	-	-	-	± 5	ns	For CLKMC (PLL input clock) $\geq 4\text{MHz}$
Input clock pulse width	P_{WH}, P_{WL}	X0,X1	8	-	-	ns	Duty ratio is about 30% to 70%
Input clock pulse width	P_{WHL}, P_{WLL}	X0A,X1A	5	-	-	μs	





Refer to the Hardware Manual for detailed Timing Charts

($T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $I_{O\text{drive}} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Conditions	Value		Unit	Remarks
				Min	Max		
RDX $\uparrow \Rightarrow$ ALE $\uparrow$ time	t_{RHLH}	RDX, ALE	EACL:STS=1 and EACL:ACE=1	$3t_{\text{CYC}}/2 - 10$	-	ns	
			other ECL:STS, EACL:ACE setting	$t_{\text{CYC}}/2 - 10$	-		
Valid address $\Rightarrow$ ECLK $\uparrow$ time	t_{AVCH}	A[23:16], ECLK	-	$t_{\text{CYC}} - 15$	-	ns	
	t_{ADVCH}	AD[15:0], ECLK		$t_{\text{CYC}}/2 - 15$	-		
RDX $\downarrow \Rightarrow$ ECLK $\uparrow$ time	t_{RLCH}	RDX, ECLK	-	$t_{\text{CYC}}/2 - 10$	-	ns	
ALE $\downarrow \Rightarrow$ RDX $\downarrow$ time	t_{LLRL}	ALE, RDX	EACL:STS=0	$t_{\text{CYC}}/2 - 10$	-	ns	
			EACL:STS=1	- 10	-		
ECLK $\uparrow \Rightarrow$ Valid data input	t_{CHDV}	AD[15:0], ECLK	-	-	$t_{\text{CYC}} - 50$	ns	

($T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $V_{CC} = 3.0$ to 4.5V , $V_{SS} = 0.0\text{ V}$, $I_{O\text{drive}} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Conditions	Value		Unit	Remarks
				Min	Max		
ALE pulse width	t _{LHLL}	ALE	EACL:STS=0 and EACL:ACE=0	t _{CYC} /2 – 8	-	ns	
			EACL:STS=1	t _{CYC} – 8	-		
			EACL:STS=0 and EACL:ACE=1	3t _{CYC} /2 – 8	-		
Valid address ⇒ ALE ↓ time	t _{AVLL}	ALE, A[23:16],	EACL:STS=0 and EACL:ACE=0	t _{CYC} – 20	-	ns	
			EACL:STS=1 and EACL:ACE=0	3t _{CYC} /2 – 20	-		
			EACL:STS=0 and EACL:ACE=1	2t _{CYC} – 20	-		
			EACL:STS=1 and EACL:ACE=1	5t _{CYC} /2 – 20	-		
	t _{ADVLL}	ALE, AD[15:0]	EACL:STS=0 and EACL:ACE=0	t _{CYC} /2 – 20	-	ns	
			EACL:STS=1 and EACL:ACE=0	t _{CYC} – 20	-		
			EACL:STS=0 and EACL:ACE=1	3t _{CYC} /2 – 20	-		
			EACL:STS=1 and EACL:ACE=1	2t _{CYC} – 20	-		
ALE ↓ ⇒ Address valid time	t _{LLAX}	ALE, AD[15:0]	EACL:STS=0	t _{CYC} /2 – 20	-	ns	
			EACL:STS=1	-20	-		
Valid address ⇒ RDX ↓ time	t _{AVRL}	RDX, A[23:16]	EACL:ACE=0	3t _{CYC} /2 – 20	-	ns	
			EACL:ACE=1	5t _{CYC} /2 – 20	-		
	t _{ADVRL}	RDX, AD[15:0]	EACL:ACE=0	t _{CYC} – 20	-	ns	
			EACL:ACE=1	2t _{CYC} – 20	-		

($T_A = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $V_{CC} = 3.0$ to 4.5V , $V_{SS} = 0.0\text{V}$, $I_{Odrive} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
WRX pulse width	t_{WLWH}	WRX, WRXL, WRHX	-	$t_{CYC} - 8$	-	ns	w/o cycle extension
Valid data output $\Rightarrow$ WRX $\uparrow$ time	t_{DVWH}	WRX, WRLX, WRHX, AD[15:0]	-	$t_{CYC} - 25$	-	ns	w/o cycle extension
WRX $\uparrow \Rightarrow$ Data hold time	t_{WHDX}	WRX, WRLX, WRHX, AD[15:0]	-	$t_{CYC}/2 - 20$	-	ns	
WRX $\uparrow \Rightarrow$ Address valid time	t_{WHAX}	WRX, WRLX, WRHX, A[23:16]	-	$t_{CYC}/2 - 20$	-	ns	
WRX $\uparrow \Rightarrow$ ALE $\uparrow$ time	t_{WHLH}	WRX, WRLX, WRHX, ALE	EBM:ACE=1 and EACL:STS=1	$2t_{CYC} - 15$	-	ns	
			other EBM:ACE and EACL:STS setting	$t_{CYC} - 15$	-		
WRX $\downarrow \Rightarrow$ ECLK $\uparrow$ time	t_{WLCH}	WRX, WRLX, WRHX, ECLK	-	$t_{CYC}/2 - 15$	-	ns	
CSn $\Rightarrow$ WRX time	t_{CSLWL}	WRX, WRLX, WRHX, CSn	EACL:ACE=0	-	$3t_{CYC}/2 - 20$	ns	
			EACL:ACE=1	-	$5t_{CYC}/2 - 20$		
WRX $\Rightarrow$ CSn time	t_{WHCSH}	WRX, WRLX, WRHX, CSn	-	$t_{CYC}/2 - 20$	-	ns	

14.6 Alarm Comparator

($T_A = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$, $V_{CC} = AV_{CC} = 3.0\text{V} - 5.5\text{V}$, $V_{SS} = AV_{SS} = 0\text{V}$)

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Power supply current	I_{A5ALMF}	AV_{CC}	-	25	45	μA	Alarm comparator enabled in fast mode (one channel)
	I_{A5ALMS}		-	7	13	μA	Alarm comparator enabled in slow mode (one channel)
	I_{A5ALMH}		-	-	5	μA	Alarm comparator disabled
ALARM pin input current	I_{ALIN}	ALARM0, ALARM1	-1	-	+1	μA	$T_A = 25\text{ }^{\circ}\text{C}$
			-3	-	+3	μA	$T_A = 125\text{ }^{\circ}\text{C}$
ALARM pin input voltage range	V_{ALIN}		0	-	AV_{CC}	V	
External low threshold high->low transition	$V_{EVTL(H\rightarrow L)}$		$0.36 * AV_{CC} - 0.25$	$0.36 * AV_{CC} - 0.1$	-	V	INTREF = 0
External low threshold low->high transition	$V_{EVTL(L\rightarrow H)}$		-	$0.36 * AV_{CC} + 0.1$	$0.36 * AV_{CC} + 0.25$	V	
External high threshold high->low transition	$V_{EVTH(H\rightarrow L)}$		$0.78 * AV_{CC} - 0.25$	$0.78 * AV_{CC} - 0.1$	-	V	
External high threshold low->high transition	$V_{EVTH(L\rightarrow H)}$			$0.78 * AV_{CC} + 0.1$	$0.78 * AV_{CC} + 0.25$	V	
Internal low threshold high->low transition	$V_{IVTL(H\rightarrow L)}$		0.9	1.1	-	V	INTREF = 1
Internal low threshold low->high transition	$V_{IVTL(L\rightarrow H)}$		-	1.3	1.55	V	
Internal high threshold high->low transition	$V_{IVTH(H\rightarrow L)}$		2.2	2.4	-	V	
Internal high threshold low->high transition	$V_{IVTH(L\rightarrow H)}$		-	2.6	2.85	V	
Switching hysteresis	V_{HYS}		50	-	300	mV	
Comparison time	t_{COMPF}		-	0.1	1	μs	CMD = 1 (fast)
	t_{COMPS}		-	1	10	μs	CMD = 0 (slow)
Power-up stabilization time after enabling alarm comparator	t_{PD}		-	1	5	ms	Threshold levels specified above are not guaranteed within this time
Slow/Fast mode transition time	t_{CMD}		-	100	500	μs	

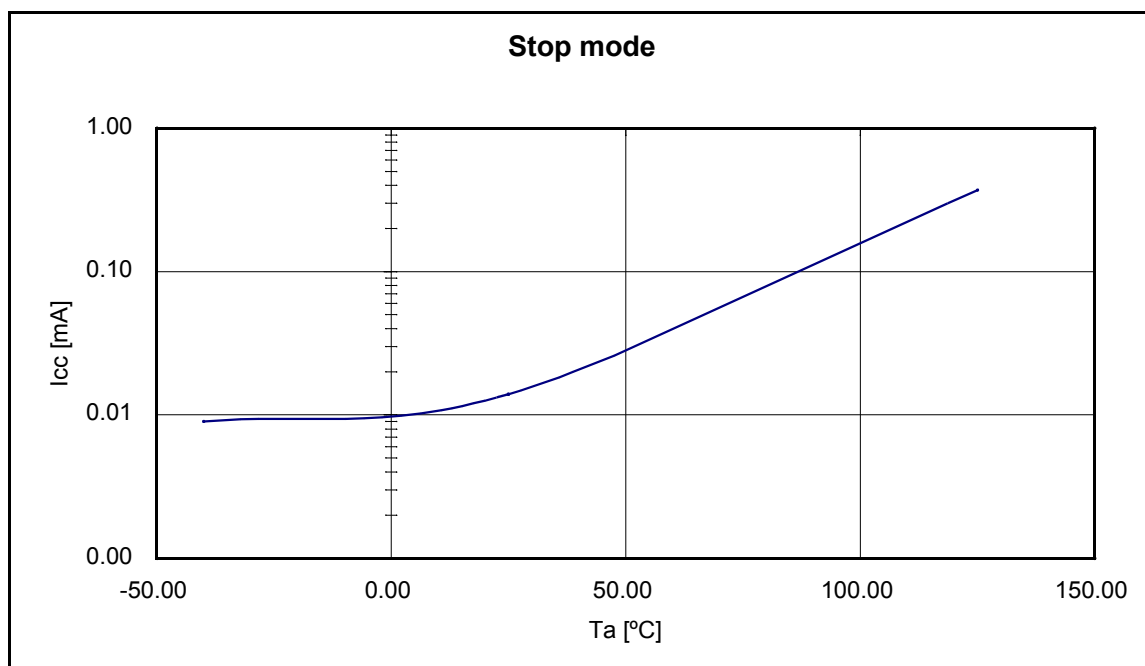
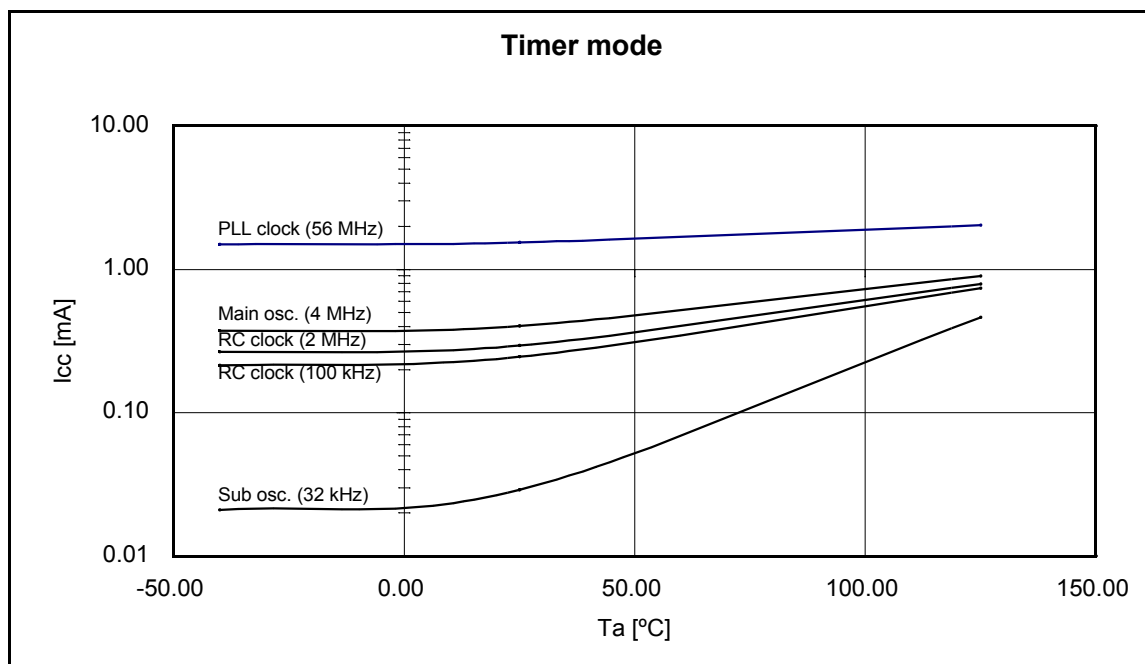
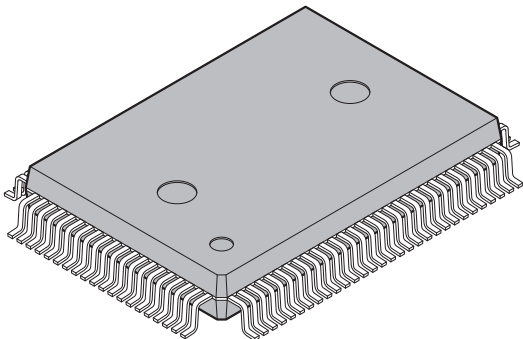
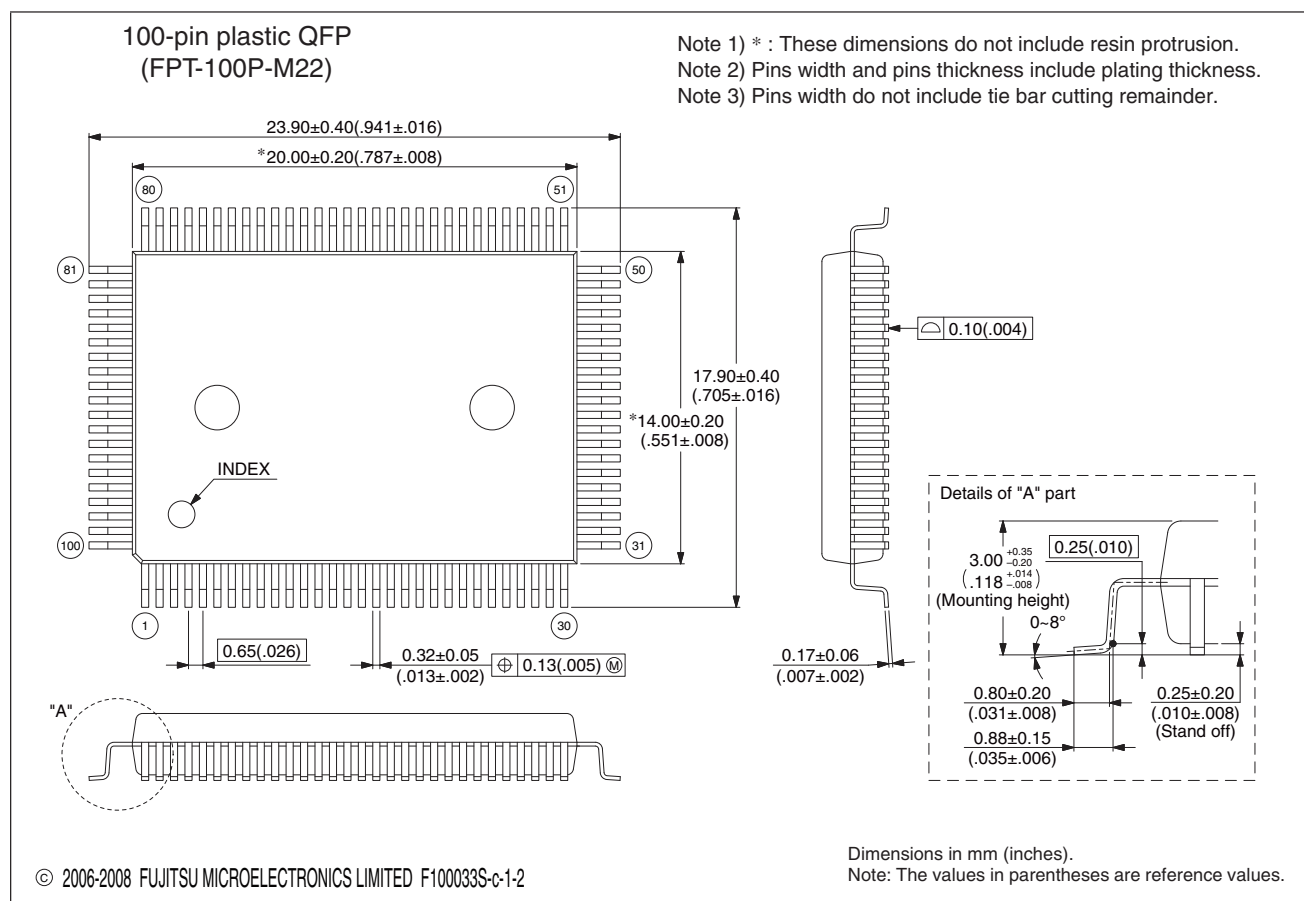


Table 6: Used settings

Mode	Selected Source Clock	Clock/Regulator Settings
Timer mode	PLL	CLKMC = 4 MHz, CLKPLL = 56 MHz (System clocks are stopped in this mode) Regulator in High Power Mode, Core Voltage = 1.9 V
	Main osc.	CLKMC = 4 MHz (System clocks are stopped in this mode) Regulator in High Power Mode, Core Voltage = 1.8 V
	RC clock fast	CLKRC = 2 MHz (System clocks are stopped in this mode) Regulator in High Power Mode, Core Voltage = 1.8 V
	RC clock slow	CLKRC = 100 kHz (System clocks are stopped in this mode) Regulator in High Power Mode, Core Voltage = 1.8 V
	Sub osc.	CLKSC = 100 kHz (System clocks are stopped in this mode) Regulator in Low Power Mode A, Core Voltage = 1.8 V
Stop mode	stopped	(All clocks are stopped in this mode) Regulator in Low Power Mode B, Core Voltage = 1.8 V

17. Package Dimension MB96(F)34x QFP 100P

100-pin plastic QFP  (FPT-100P-M22)	Lead pitch	0.65 mm
	Package width × package length	14.00 mm × 20.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	3.35 mm MAX
	Code (Reference)	P-QFP100-14×20-0.65



19. Revision History

Revision	Date	Modification
Prelim 1	2007-05-07	Creation
Prelim 2	2007-05-10	External bus hold timing update
Prelim 3	2007-05-23	Electrical characteristics updates
Prelim 4	2007-08-02	Electrical characteristics updates, Product lineup, changes and ordering information
Prelim 5	2007-09-12	Addition of the electrical characteristic examples and the LVD characteristics specifications, updates of the DC characteristics. Pin circuit type drawing modifications.
Prelim 6	2007-11-21	LVD typo correction. Update of the DC characteristics. Typos corrections.
Prelim 7	2007-12-04	Absolute maximum rating asterisks numbering corrected. Typos page 59: Hardware -> Hardware. IO map table regenerated. Typos corrections. IO circuit drawings modified. Renaming of the Main/Satellite Flash into Flash memory A/B. Memory map reworked.
Prelim 8	2008-02-04	■ Satellite Flash -> 32kB Data Flash ■ MB96345 added (under development) ■ MB96F348 TSA/HSA/TWA/HWA removed (outdated devices) ■ Block diagram and pin assignment corrected (existing resource pins) ■ Pin function table corrected ■ I/O circuit type diagrams corrected ■ Memory map cleaned up ■ "Flash sector configuration" replaced by corrected "User ROM Memory map for Flash devices", "ROM configuration" replaced by "User ROM Memory map for Mask ROM devices" ■ Parallel Flash programming pinning removed ■ IO map table regenerated: □ Port register: Naming style corrected □ Memory control registers renamed (Main/Sat -> A/B) □ addresses after 000BFFh removed ■ Absolute maximum ratings: Pd and Ta specified more precisely ■ oscillator input levels in oscillation mode with external clock added ■ Run and Sleep mode currents: 96/48MHz and 72/36MHz settings added ■ Run mode current spec in 48/24MHz mode corrected ■ Maximum CLKS1/2 frequency for all devices correctly specified ■ Maximum CLKP2 for MB96F34xY/R/Axx corrected ■ External bus timings: missing conditions added and readability improved ■ Alarm comparator spec updated (transition voltages defined) ■ MB96V300A removed ■ Ordering information updated ■ Typos and formatting corrected